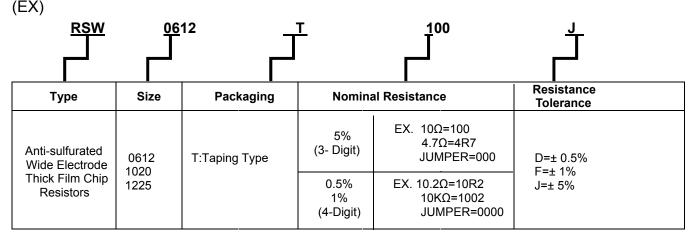


1 Scope:

- 1.1 This specification is applicable to lead free and halogen free of RoHS directive for RSW series anti-sulfurated wide terminal thick film chip resistors.
- 1.2 Superior sulfur resistant capability (Refer to ASTM-B-809-95&EIA977 sulfur vapor test).
- 1.3 The product is for general electronic purpose.

2 Explanation Of Part Numbers:



3 General Specifications:

Туре	Rated Power at	•	Max. Overload	T.C.R (ppm/℃)			JUM (0) Rai Cur	Ω) ted	JUM (09 Resis Val	Ω) tance
	70°C	Voltage	Voltage		D(±0.5%)F(±1%) E-24 ∖ E-96	J(±5%) E-24	J (±5%)	F (±1%)	J (±5%)	F (±1%)
RSW	<u>3</u> 4	200V	400V	±200	$1\Omega{\leq}R{<}10\Omega$	$1\Omega{\leq}R{<}10\Omega$	2A	4A	50mΩ	20mΩ
(0612)	4	2007	4000	±100	$10\Omega{\leq}R{\leq}1M\Omega$	$10\Omega{\leq}R{\leq}1M\Omega$	2A	-74	MAX.	MAX.
RSW	1W	200V	400V	±200	$1\Omega{\leq}R{<}10\Omega$	$1\Omega{\leq}R{<}10\Omega$	2A	7A	50mΩ	20mΩ
(1020)	IVV	2000	4000	±100	$10\Omega{\leq}R{\leq}1M\Omega$	$10\Omega{\leq}R{\leq}1M\Omega$	24		MAX.	MAX.
RSW	2W	2001/	4001/	±200	$1\Omega{\leq}R{<}10\Omega$	$1\Omega{\leq}R{<}10\Omega$	24	0.54	50mΩ	20mΩ
(1225)	(1225)		200V 400V	±100	$10\Omega{\leq}R{\leq}1M\Omega$	$10\Omega{\leq}R{\leq}1M\Omega$	2A	8.5A	MAX.	MAX.
Operating Temperature Range					-55℃ ~+155℃	2				

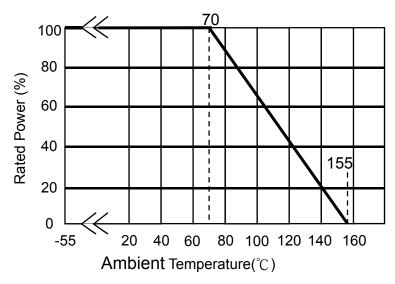
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3.1 Power Derating Curve:

Operating Temperature Range : - 55 $\,\sim\,$ 155 $^\circ \! \mathbb{C}$

If the ambient temperature exceeds 70 degrees centigrade to 155 degrees centigrade, the power can be modified by the curve as below.



3.2 Voltage Rating:

Rated Voltage: DC voltage or AC voltage (rms) based on the rated power.

The voltage can be calculated by the following formula. If the calculated value exceeds the Max. voltage specified in the Table 3, the Max. voltage rating is set as the voltage rating.

$$E=\sqrt{R \times P}$$

E= Rated voltage(V) P= Power rating(W) R= Nominal resistance(Ω)

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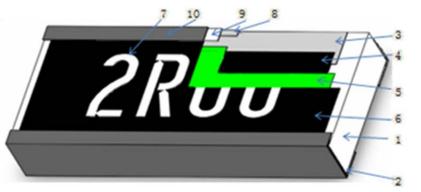


4 Dimensions:



						Unit:mm
Туре	Dimension Size Code	L	W	н	L1	L2
RSW	0612	1.60±0.20	3.20±0.20	0.55±0.10	0.35±0.15	0.25±0.15
RSW	1020	2.50±0.20	5.00±0.20	0.55±0.10	0.25±0.20	0.90±0.20
RSW25	1225	3.20±0.20	6.40±0.20	0.55±0.10	0.45±0.20	0.75±0.20

5 Structure Graph:



1	Ceramic substrate	6	2nd Protective coating
2	Bottom inner electrode	7	Marking
3	Top inner electrode	8	Terminal inner electrode
4	Resistive layer	9	Ni plating
5	1st Protective coating	10	Sn plating

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6 Reliability Test:

6.1 Electrical Performance Test

Itom	Conditions	Specifications	
Item	Conditions	Resistors	Jumper
	TCR (ppm / °C) = $\frac{(R2-R1)}{R1(T2-T1)}$ ×10 ⁶	Refer to item 3. General specifications	NA
Temperature	R1: Resistance at room temperature(Ω)		
Coefficient of	R2: Resistance at -55°C or +125°C (Ω)		
Resistance	T1: Room temperature(°C)		
	T2:Temperature -55° $⊂$ or +125° $⊂$ (° $⊂$).		
	Refer to JIS-C5201-1 4.8		
		0.5% 丶 1%:△R=±1.0%	Refer to
	2seconds and let stand for more than 30 minutes before measuring the resistance change rate.	5%:△R=±2.0%	item 3. general
	(Rated voltage refer to item 3. general specifications)		specifica
oveneda			tions
	Refer to JIS-C5201-1 4.13		
		No short or burned on the appe	arance.
	below) in +,- terminal for.		
	RSW(0612) apply 400VAC 1 minute. RSW(1020)apply 500VAC 1minute		
	RSW(1020)apply500VAC 1 minute RSW(1225) apply500VAC 1 minute		
voltage			
	Refer to JIS-C5201-1 4.7		
	Put it in the thermostat, apply 2.0 times rated voltage, 1		Refer to
	second ON, 25 seconds OFF, count 10000+400/-0 times,		item 3.
	take it out and stand for 60 minutes, then measure the		general
	change of resistance value. Jumper: Applied Maximum overload current		specifica tions
	Type RSW RSW RSW		10113
	Jumper (0612) (1020) (1225)		
	±5% 4A 4A 4A		
	±1% 8A 14A 17A		
	Refer to JIS-C5201-1 4.13		

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6.2 Mechanical Performance Test

Iter	m	Conditions	Specifications	
Soldera	ability		Resistors Solder coverage over 95%	Jumper
Resista Solderin	nce to g Heat	The tested resistor be immersed into molten solder of $260+5/-0^{\circ}$ for $30+1/-0$ seconds.Then remove and wash it to observe the solder area under a microscope. Test method 3 (Electric iron test): Preheating temperature : $350\pm10^{\circ}$ C Electric iron preheating time : $3+1/-0$ sec	 Test item 1: (1)Variance rate on resistance △R=±1.0% Test item 2 (1)Solder coverage over 95% ∘ (2)The underlying material (such as ceramic) shall not be visible at the crest corner area of the electrode. Test item 3: (1) Variance rate on resistance. △R=±1.0% 	Refer to item 3. general specifica tions
Joint Str of Sol	rength	Refer to JIS-C5201-1 4.18 Bending Strength Test: Solder chip resistors on to bending test plate and placed on the bending test machine. Apply pressure in the center of the test plate and measure the rate of change of resistance under load D:RSW0612=3mm RSW1020 \ RSW1225=2mm Resistor Testing circuit boord Chip resistor (Arrount of bend) Refer to JIS-C5201-1 4.33		Refer to item 3. general specifica tions
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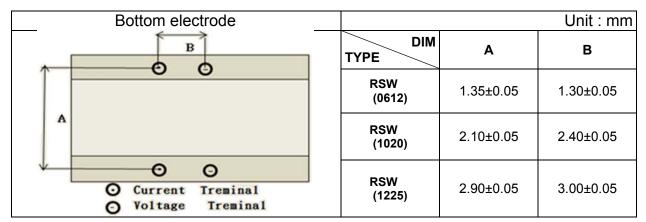
6.3 Environmental Test

It	tem	Conditions		Specifications	
		Put tostad register in the over under temperature 455 (Jumper Refer to item
		Put tested resistor in the oven under temperature 155 ± 5 °C for 1000 +48/-0 hours. Then take out and let stand	0.5%	=±1.0%	3. general
Res	sistance	for more than 1 hour before measuring the resistance	570. <u>_</u> 1(-±2.070		specifications
		change rate			
		PS:RSW0612 for 125±3℃.			
		Refer to JIS-C5201-1 4.25			
		Put chip resistors in the thermal shock machine ,and the		=±0.5%	Refer to item
		temperature was -55° C for 15 minutes and $+125^{\circ}$ C for 15 minutes, the total of 300 times and then removed, let			 general specifications
		stand for more than 1 hour before measuring the			opeenieatione
		resistance change rate			
The	ermal	,			
	nock	Testing Condition			
		Lowest Temperature -55±5℃ Highest Temperature 125±5℃			
		Temperature-retaining			
		time 15 minutes each			
		Refer to MIL-STD 202 Method 107			
		Put the tested resistor in the constant temperature and	±5.0%		Refer to item
		humidity tank, under temperature 40±2°C, relative			3. general
المحط		humidity 90~95% and load the rated voltage for 90			specifications
Load		minutes on, 30 minutes off, total 1000 hours. Then take out and let stand for more than 1 hour before measuring			
	olotaro	the resistance change rate	1		
		Refer to JIS-C5201-1 4.24 Put the tested resistor in the oven under temperature	±5.0%		Refer to item
		70±2°C and load the rated voltage for 90 minutes on, 30			3. general
1	al 1 : f a	minutes off, total 1000 hours. Then take out and let			specifications
Loa	ld Life	stand for more than 1 hour before measuring the resistance change rate			
		Refer toJIS-C5201-1 4.25			
		Class:B Put the tested resistor in sulfur vapor, at a temperature	△R=±4.0%		Refer to item 3. general
	uration	of $105\pm2^{\circ}$ for 750 hrs			specifications
	est				
		Refer toASTM-B-809-95&EIA977			
	est				s
	1			1	
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7 Measurement Point :



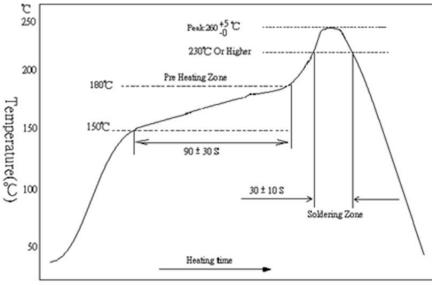
8 Plating Thickness :

- 8.1 Ni: \geq 2 μ m
- 8.2 Sn(Tin): \geq 3 μ m
- 8.3 Sn(Tin):Matte Sn

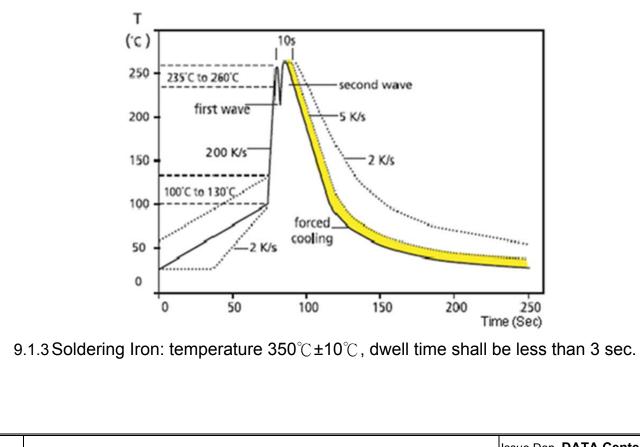
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- 9 Technical application notes: (This is a recommendation, please adjust it according to actual application)
 - 9.1 Recommend Soldering Method:
 - 9.1.1 Lead Free IR Reflow Soldering Profile



Remark: The peak temperature of soldering heat is $260 + 5/-0^{\circ}$ for 10 seconds 9.1.2 Lead Free Double-Wave Soldering Profile



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9.2 Land Pattern Design (For Reflow Soldering) :

When a component is soldered, the resistance after soldering changes slightly depending on the size of the soldering area and the amount of soldering. When designing a circuit, it is necessary to consider the effect of a decrease or increase in its resistance.

Unit:mm

\frown	DIM	Α	В	С
с	RSW (0612)	0.7	2.6	3.5
	RSW (1020)	0.5	3.5	5.3
	RSW (1225)	1.3	4.2	6.4

9.3 Environment Precautions:

This specification product is for general electronic use, RALEC will not be responsible for any damage, cost or loss caused by using this specification product in any special environment. If other applications, you need to confirm with RALEC.

If consumer intends to use our Company product in special environment or condition (including but not limited to those mentioned below), then will need to make individual recognition of product features and reliability accordingly.

- (a) Used in high temperature and humidity environment.
- (b) Exposed to sea breeze or other corrosive gas, such as Cl2
 H2S
 NH3
 SO2 and NO2.
- (c) Used in non-verified liquids including water, oil, chemical and organic solvents.
- (d) Using non-verified resin or other coating material to seal or coat our Company product.
- (e) After soldering, it is necessary to use water-soluble detergents to clean residual solder fluxes, even though no-clean fluxes are recommended.

9.4 Momentary Overload Precautions:

The product might be out of function when momentary overloaded. Please make sure to avoid momentary overloading while using and preserving

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- 9.5 Operation and Processing Precautions:
 - (a) Avoid damage to the edge of resistor and protective layer caused by mechanical stress.
 - (b) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
 - (c) Make sure the power rating is under the limit when using the resistor. When power rating is over the limit, the resister will be overloaded. There might be machinery damage due to the climbing temperature.
 - (d) If the resister will be exposed under massive impact load (shock wave) in a short period of time, the working environment must be set up well before use.
 - (e) Please make evaluation and confirmation when the product is well used in your company and have a through consideration of it's fail-safe design to ensure the system safety.

10 Stock period:

- 10.1The temperature condition must be controlled at 25±5℃, the R.H. must be controlled at 60±15%. The stock can maintain quality level in two years.
- 10.2Please avoid the mentioned harsh environment below when storing to ensure product performance and its weldability. Places exposed to sea breeze or other corrosive gas, such as $CI_2 \times H_2S \times NH_3 \times SO_2$ and NO_2 .
- 10.3When the product is moved and stored, please ensure the correct orientation of the box. Do not drop or squeeze the box. Otherwise, the electrode or the body of the product may be damaged.

11 The carton packaged for electronic-information products is made by the symbol as follows: (For china)



12 Attachments:

14.1Document Revise Record

(QA-QR-027)

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